Kingbright

14.22mm (0.56INCH) THREE DIGIT NUMERIC DISPLAY

Part Number: BA56-11SRWA Super Bright Red

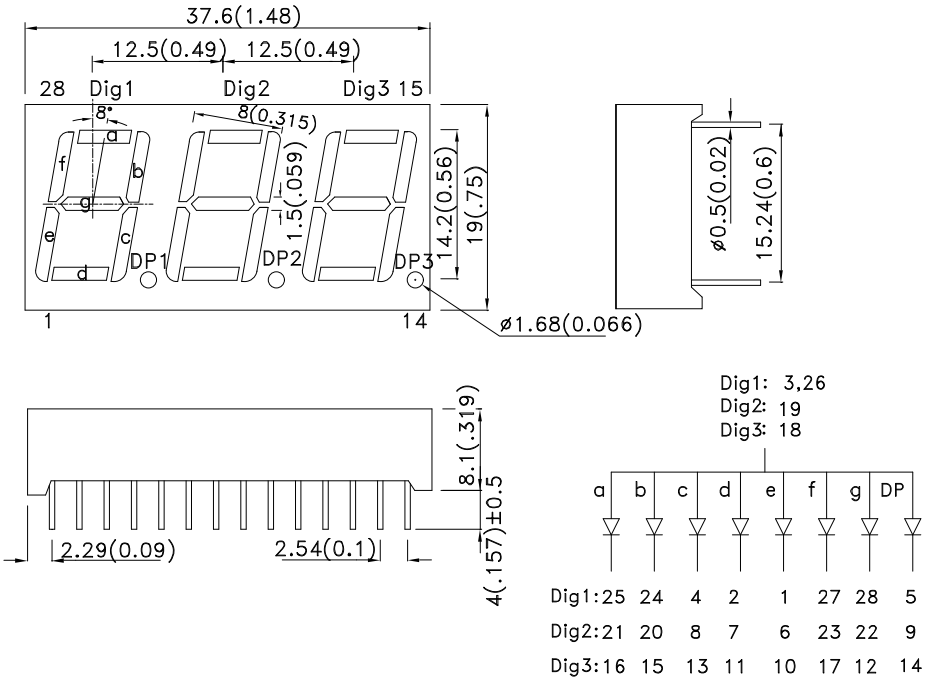
Features

- 0.56 INCH DIGIT HEIGHT.
- LOW CURRENT OPERATION.
- EXCELLENT CHARACTER APPEARANCE.
- EASY MOUNTING ON P.C. BOARDS OR SOCKETS.
- I.C. COMPATIBLE.
- MECHANICALLY RUGGED.
- STANDARD: GRAY FACE, WHITE SEGMENT.
- RoHS COMPLIANT.

Description

The Super Bright Red source color devices are made with Gallium Aluminum Arsenide Red Light Emitting Diode.

Package Dimensions& Internal Circuit Diagram



Notes:
1. All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01")unless otherwise noted.
2. Specifications are subject to change without notice.

Selection Guide

Part No.	Dice	Lens Type	Iv (ucd) [1] @ 10mA		Description
			Min.	Typ.	
BA56-11SRWA	Super Bright Red (GaAlAs)	WHITE DIFFUSED	12000	45000	Common Anode ,Rt. Hand Decimal.

Note:
1. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

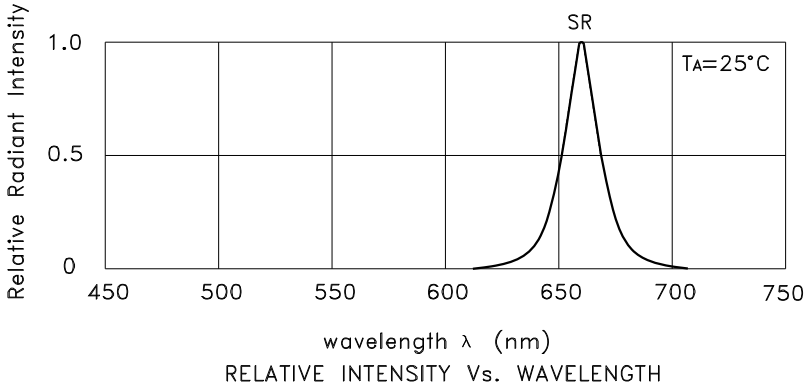
Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Red	660		nm	I_F=20mA
λD [1]	Dominant Wavelength	Super Bright Red	640		nm	I_F=20mA
Δλ1/2	Spectral Line Half-width	Super Bright Red	20		nm	I_F=20mA
C	Capacitance	Super Bright Red	45		pF	V_F=0V;f=1MHz
V_F [2]	Forward Voltage	Super Bright Red	1.85	2.5	V	I_F=20mA
I_R	Reverse Current	Super Bright Red		10	uA	V_R=5V

Notes:
1.Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

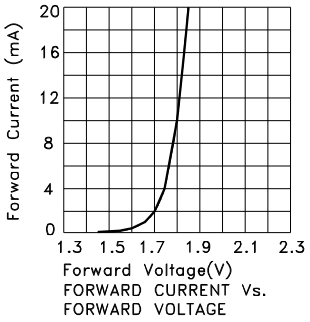
Parameter	Super Bright Red	Units
Power dissipation	75	mW
DC Forward Current	30	mA
Peak Forward Current [1]	155	mA
Reverse Voltage	5	V
Operating / Storage Temperature	-40°C To +85°C	
Lead Solder Temperature[2]	260°C For 3-5 Seconds	

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. 2mm below package base.

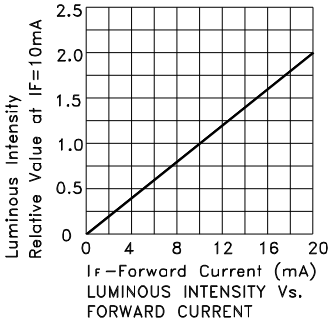


RELATIVE INTENSITY Vs. WAVELENGTH

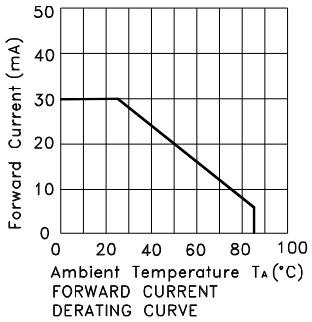
Super Bright Red **BA56-11SRWA**



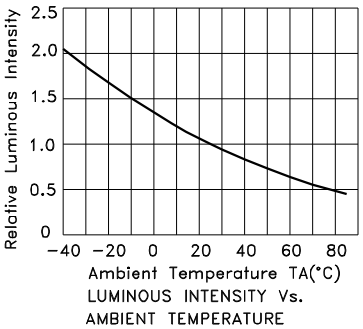
FORWARD CURRENT Vs.
FORWARD VOLTAGE



LUMINOUS INTENSITY Vs.
FORWARD CURRENT

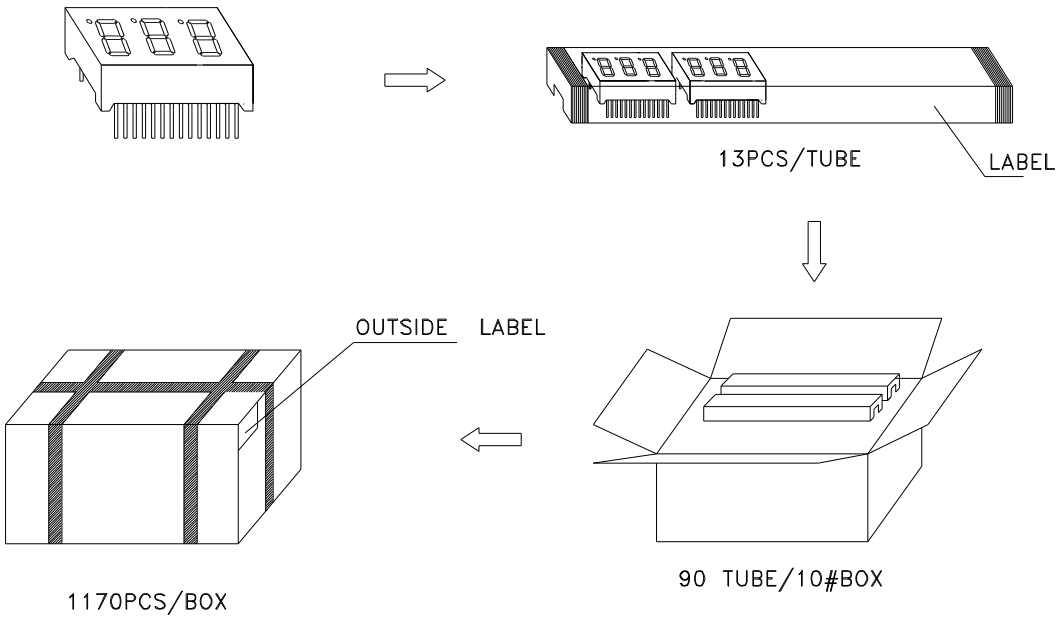


FORWARD CURRENT
DERATING CURVE

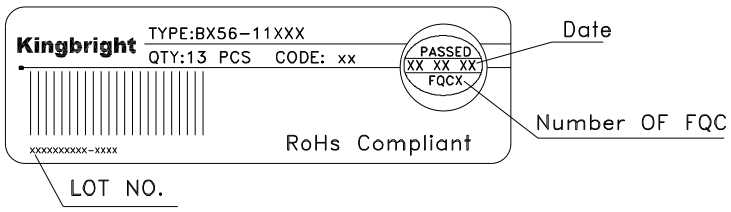


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE

PACKING & LABEL SPECIFICATIONS **BA56-11SRWA**



Inside LABEL Paste On The IC-tube



Outside LABEL Paste On The Box

